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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	I ² C, Microwire, SmartCard, SPI, SSP, UART/USART
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	40
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	12K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc11e37fbd48-501e

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- Debug options:
 - Standard JTAG (Joint Test Action Group) test interface for BSDL (Boundary Scan Description Language).
 - Serial Wire Debug.
- Digital peripherals:
 - Up to 54 General Purpose I/O (GPIO) pins with configurable pull-up/pull-down resistors, repeater mode, and open-drain mode.
 - ♦ Up to 8 GPIO pins can be selected as edge and level sensitive interrupt sources.
 - Two GPIO grouped interrupt modules enable an interrupt based on a programmable pattern of input states of a group of GPIO pins.
 - ◆ High-current source output driver (20 mA) on one pin.
 - High-current sink driver (20 mA) on true open-drain pins.
 - Four general purpose counter/timers with a total of up to 8 capture inputs and 13 match outputs.
 - Programmable Windowed WatchDog Timer (WWDT) with a dedicated, internal low-power WatchDog Oscillator (WDO).
- Analog peripherals:
 - ◆ 10-bit ADC with input multiplexing among eight pins.
- Serial interfaces:
 - USART with fractional baud rate generation, internal FIFO, a full modem control handshake interface, and support for RS-485/9-bit mode and synchronous mode. USART supports an asynchronous smart card interface (ISO 7816-3).
 - Two SSP controllers with FIFO and multi-protocol capabilities.
 - I²C-bus interface supporting the full I²C-bus specification and Fast-mode Plus with a data rate of up to 1 Mbit/s with multiple address recognition and monitor mode.
- I/O Handler for hardware emulation of serial interfaces and DMA; supported through software libraries.(LPC11E37HFBD64/401 only.)
- Clock generation:
 - Crystal Oscillator with an operating range of 1 MHz to 25 MHz (system oscillator).
 - 12 MHz high-frequency Internal RC oscillator (IRC) that can optionally be used as a system clock.
 - Internal low-power, low-frequency WatchDog Oscillator (WDO) with programmable frequency output.
 - PLL allows CPU operation up to the maximum CPU rate with the system oscillator or the IRC as clock sources.
 - Clock output function with divider that can reflect the crystal oscillator, the main clock, the IRC, or the watchdog oscillator.
- Power control:
 - Integrated PMU (Power Management Unit) to minimize power consumption during Sleep, Deep-sleep, Power-down, and Deep power-down modes.
 - Power profiles residing in boot ROM provide optimized performance and minimized power consumption for any given application through one simple function call.
 - Four reduced power modes: Sleep, Deep-sleep, Power-down, and Deep power-down.
 - Processor wake-up from Deep-sleep and Power-down modes via reset, selectable GPIO pins, or the watchdog interrupt.
 - ◆ Processor wake-up from Deep power-down mode using one special function pin.

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- ◆ Power-On Reset (POR).
- Brownout detect with four separate thresholds for interrupt and forced reset.
- Unique device serial number for identification.
- Single 3.3 V power supply (1.8 V to 3.6 V).
- Temperature range –40 °C to +85 °C.
- Available as LQFP64, LQFP48, and HVQFN33 packages.

3. Applications

- Consumer peripherals
- Medical

- Handheld scanners
- Industrial control

4. Ordering information

Table 1.Ordering information

Type number	Package								
	Name	Description	Version						
LPC11E35FHI33/501	HVQFN33	plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body $5 \times 5 \times 0.85$ mm	n/a						
LPC11E36FBD64/501	LQFP64	plastic low profile quad flat package; 64 leads; body $10 \times 10 \times 1.4$ mm	SOT314-2						
LPC11E36FHN33/501	HVQFN33	plastic thermal enhanced very thin quad flat package; no leads; 33 terminals; body 7 \times 7 \times 0.85 mm	n/a						
LPC11E37FBD48/501	LQFP48	plastic low profile quad flat package; 48 leads; body $7 \times 7 \times 1.4$ mm	SOT313-2						
LPC11E37FBD64/501	LQFP64	plastic low profile quad flat package; 64 leads; body $10 \times 10 \times 1.4$ mm	SOT314-2						
LPC11E37HFBD64/401	LQFP64	plastic low profile quad flat package; 64 leads; body $10 \times 10 \times 1.4$ mm	SOT314-2						

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Block diagram 5.



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Table 3.Pin description

Symbol	Pin HVQFN33 (5x5)	Pin HVQFN33 (7x7)	Pin LQFP48	Pin LQFP64		Reset state [1]	Туре	Description
PIO1_5/CT32B1_CAP1/ IOH_15	-	-	-	32	[3]	I; PU	I/O	PIO1_5 — General purpose digital input/output pin.
						-	I	CT32B1_CAP1 — Capture input 1 for 32-bit timer 1.
						-	I/O	IOH_15 — I/O Handler input/output 15. (LPC11E37HFBD64/401 only.)
PIO1_6/IOH_16	-	-	-	64	[3]	I; PU	I/O	PIO1_6 — General purpose digital input/output pin.
						-	I/O	IOH_16 — I/O Handler input/output 16. (LPC11E37HFBD64/401 only.)
PIO1_7/IOH_17	-	-	-	6	[3]	I; PU	I/O	PIO1_7 — General purpose digital input/output pin.
						-	I/O	IOH_17 — I/O Handler input/output 17. (LPC11E37HFBD64/401 only.)
PIO1_8/IOH_18	-	-	-	39	[3]	I; PU	I/O	PIO1_8 — General purpose digital input/output pin.
						-	I/O	IOH_18 — I/O Handler input/output 18. (LPC11E37HFBD64/401 only.)
PIO1_9	-	-	-	55	<u>[3]</u>	I; PU	I/O	PIO1_9 — General purpose digital input/output pin.
PIO1_10	-	-	-	12	[3]	I; PU	I/O	PIO1_10 — General purpose digital input/output pin.
PIO1_11	-	-	-	43	[3]	I; PU	I/O	PIO1_11 — General purpose digital input/output pin.
PIO1_12	-	-	-	59	[3]	I; PU	I/O	PIO1_12 — General purpose digital input/output pin.
PIO1_13/DTR/ CT16B0_MAT0/TXD	-	-	36	47	[3]	I; PU	I/O	PIO1_13 — General purpose digital input/output pin.
						-	0	DTR — Data Terminal Ready output for USART.
						-	0	CT16B0_MAT0 — Match output 0 for 16-bit timer 0.
						-	0	TXD — Transmitter output for USART.
PIO1_14/DSR/ CT16B0_MAT1/RXD	-	-	37	49	[3]	I; PU	I/O	PIO1_14 — General purpose digital input/output pin.
						-	I	DSR — Data Set Ready input for USART.
						-	0	CT16B0_MAT1 — Match output 1 for 16-bit timer 0.
						-	I	RXD — Receiver input for USART.

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Symbol	Pin HVQFN33 (5x5)	Pin HVQFN33 (7x7)	Pin LQFP48	Pin LQFP64		Reset state [1]	Туре	Description
XTALIN	4	4	6	8	<u>[7]</u>	-	-	Input to the oscillator circuit and internal clock generator circuits. Input voltage must not exceed 1.8 V.
XTALOUT	5	5	7	9	[7]	-	-	Output from the oscillator amplifier.
V _{DD}	6; 29	6; 29	8; 44	10; 33; 48; 58		-	-	Supply voltage to the internal regulator, the external rail, and the ADC. Also used as the ADC reference voltage.
V _{SS}	33; 13; 14	33	5; 41	7; 54		-	-	Ground.

Table 3. Pin description

[1] Pin state at reset for default function: I = Input; O = Output; PU = internal pull-up enabled; IA = inactive, no pull-up/down enabled; F = floating; If the pins are not used, tie floating pins to ground or power to minimize power consumption.

- [2] 5 V tolerant pad. RESET functionality is not available in Deep power-down mode. Use the WAKEUP pin to reset the chip and wake up from Deep power-down mode. An external pull-up resistor is required on this pin for the Deep power-down mode. See <u>Figure 29</u> for the reset pad configuration.
- [3] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see Figure 28).
- [4] I²C-bus pins compliant with the I²C-bus specification for I²C standard mode, I²C Fast-mode, and I²C Fast-mode Plus.
- [5] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors and configurable hysteresis (see Figure 28); includes high-current output driver.
- [6] 5 V tolerant pad providing digital I/O functions with configurable pull-up/pull-down resistors, configurable hysteresis, and analog input. When configured as a ADC input, digital section of the pad is disabled and the pin is not 5 V tolerant (see <u>Figure 28</u>); includes digital input glitch filter.
- [7] When the system oscillator is not used, connect XTALIN and XTALOUT as follows: XTALIN can be left floating or can be grounded (grounding is preferred to reduce susceptibility to noise). Leave XTALOUT floating.

7. Functional description

7.1 On-chip flash programming memory

The LPC11E3x contain up to 128 kB on-chip flash program memory. The flash can be programmed using In-System Programming (ISP) or In-Application Programming (IAP) via the on-chip boot loader software.

The flash memory is divided into 4 kB sectors with each sector consisting of 16 pages. Individual pages can be erased using the IAP erase page command.

7.2 EEPROM

The LPC11E3x contain 4 kB of on-chip byte-erasable and byte-programmable EEPROM data memory. The EEPROM can be programmed using In-Application Programming (IAP) via the on-chip boot loader software.

- Four programmable interrupt priority levels, with hardware priority level masking.
- Software interrupt generation.

7.6.2 Interrupt sources

Each peripheral device has one interrupt line connected to the NVIC but can have several interrupt flags. Individual interrupt flags can also represent more than one interrupt source.

7.7 IOCON block

The IOCON block allows selected pins of the microcontroller to have more than one function. Configuration registers control the multiplexers to allow connection between the pin and the on-chip peripherals.

Connect peripherals to the appropriate pins before activating the peripheral and before enabling any related interrupt. Activity of any enabled peripheral function that is not mapped to a related pin is treated as undefined.

7.7.1 Features

- Programmable pull-up, pull-down, or repeater mode.
- All GPIO pins (except PIO0_4 and PIO0_5) are pulled up to 3.3 V (V_{DD} = 3.3 V) if their pull-up resistor is enabled.
- Programmable pseudo open-drain mode.
- Programmable 10 ns glitch filter on pins PIO0_22, PIO0_23, and PIO0_11 to PIO0_16. The glitch filter is turned on by default.
- Programmable hysteresis.
- Programmable input inverter.

7.8 General-Purpose Input/Output GPIO

The GPIO registers control device pin functions that are not connected to a specific peripheral function. Pins can be dynamically configured as inputs or outputs. Multiple outputs can be set or cleared in one write operation.

LPC11E3x use accelerated GPIO functions:

- GPIO registers are a dedicated AHB peripheral so that the fastest possible I/O timing can be achieved.
- Entire port value can be written in one instruction.

Any GPIO pin providing a digital function can be programmed to generate an interrupt on a level, a rising or falling edge, or both.

The GPIO block consists of three parts:

- 1. The GPIO ports.
- 2. The GPIO pin interrupt block to control eight GPIO pins selected as pin interrupts.
- Two GPIO group interrupt blocks to control two combined interrupts from all GPIO pins.

7.8.1 Features

- GPIO pins can be configured as input or output by software.
- All GPIO pins default to inputs with interrupt disabled at reset.
- Pin registers allow pins to be sensed and set individually.
- Up to eight GPIO pins can be selected from all GPIO pins to create an edge- or level-sensitive GPIO interrupt request.
- Any pin or pins in each port can trigger a port interrupt.

7.9 I/O Handler (LPC11E37HFBD64/401 only)

The I/O Handler is a software library-supported hardware engine for emulating serial interfaces and DMA. The I/O Handler can emulate serial interfaces such as UART, I²C, or I²S with no or very low additional CPU load. The software libraries are available with supporting application notes from NXP (see http://www.LPCware.com.) LPCXpresso, Keil, and IAR IDEs are supported. I/O Handler library code must be executed from the memory area 0x2000 0000 to 0x2000 07FF. This memory is not available for other use.

For application examples, see Section 11.7 "I/O Handler software library applications".

7.10 USART

The LPC11E3x contains one USART.

The USART includes full modem control, support for synchronous mode, and a smart card interface. The RS-485/9-bit mode allows both software address detection and automatic address detection using 9-bit mode.

The USART uses a fractional baud rate generator. Standard baud rates such as 115200 Bd can be achieved with any crystal frequency above 2 MHz.

7.10.1 Features

- Maximum USART data bit rate of 3.125 Mbit/s.
- 16 byte receive and transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B.
- Built-in fractional baud rate generator covering wide range of baud rates without a need for external crystals of particular values.
- Fractional divider for baud rate control, auto baud capabilities and FIFO control mechanism that enables software flow control implementation.
- Support for RS-485/9-bit mode.
- Support for modem control.
- Support for synchronous mode.
- Includes smart card interface.

7.15 System tick timer

The ARM Cortex-M0 includes a system tick timer (SYSTICK) that is intended to generate a dedicated SYSTICK exception at a fixed time interval (typically 10 ms).

7.16 Windowed WatchDog Timer (WWDT)

The purpose of the WWDT is to prevent an unresponsive system state. If software fails to update the watchdog within a programmable time window, the watchdog resets the microcontroller

7.16.1 Features

- Internally resets chip if not periodically reloaded during the programmable time-out period.
- Optional windowed operation requires reload to occur between a minimum and maximum time period, both programmable.
- Optional warning interrupt can be generated at a programmable time before watchdog time-out.
- Software enables the WWDT, but a hardware reset or a watchdog reset/interrupt is required to disable the WWDT.
- Incorrect feed sequence causes reset or interrupt, if enabled.
- Flag to indicate watchdog reset.
- Programmable 24-bit timer with internal prescaler.
- Selectable time period from $(T_{cy(WDCLK)} \times 256 \times 4)$ to $(T_{cy(WDCLK)} \times 2^{24} \times 4)$ in multiples of $T_{cy(WDCLK)} \times 4$.
- The Watchdog Clock (WDCLK) source can be selected from the IRC or the dedicated watchdog oscillator (WDO). The clock source selection provides a wide range of potential timing choices of watchdog operation under different power conditions.

7.17 Clocking and power control

7.17.1 Integrated oscillators

The LPC11E3x include three independent oscillators: the system oscillator, the Internal RC oscillator (IRC), and the watchdog oscillator. Each oscillator can be used for more than one purpose as required in a particular application.

Following reset, the LPC11E3x operates from the internal RC oscillator until software switches to a different clock source. The IRC allows the system to operate without any external crystal and the bootloader code to operate at a known frequency.

See Figure 7 for an overview of the LPC11E3x clock generation.

7.17.6 System control

7.17.6.1 Reset

Reset has four sources on the LPC11E3x: the RESET pin, the Watchdog reset, power-on reset (POR), and the BrownOut Detection (BOD) circuit. The RESET pin is a Schmitt trigger input pin. Assertion of chip reset by any source, once the operating voltage attains a usable level, starts the IRC and initializes the flash controller.

A LOW-going pulse as short as 50 ns resets the part.

When the internal Reset is removed, the processor begins executing at address 0, which is initially the Reset vector mapped from the boot block. At that point, all of the processor and peripheral registers have been initialized to predetermined values.

In Deep power-down mode, an external pull-up resistor is required on the RESET pin.

7.17.6.2 Brownout detection

The LPC11E3x includes four levels for monitoring the voltage on the V_{DD} pin. If this voltage falls below one of the four selected levels, the BOD asserts an interrupt signal to the NVIC. This signal can be enabled for interrupt in the Interrupt Enable Register in the NVIC to cause a CPU interrupt. Alternatively, software can monitor the signal by reading a dedicated status register. Four additional threshold levels can be selected to cause a forced reset of the chip.

7.17.6.3 Code security (Code Read Protection - CRP)

CRP provides different levels of security in the system so that access to the on-chip flash and use of the Serial Wire Debugger (SWD) and In-System Programming (ISP) can be restricted. Programming a specific pattern into a dedicated flash location invokes CRP. IAP commands are not affected by the CRP.

In addition, ISP entry via the PIO0_1 pin can be disabled without enabling CRP. For details, see the *LPC11Exx user manual*.

There are three levels of Code Read Protection:

- 1. CRP1 disables access to the chip via the SWD and allows partial flash update (excluding flash sector 0) using a limited set of the ISP commands. This mode is useful when CRP is required and flash field updates are needed but all sectors cannot be erased.
- CRP2 disables access to the chip via the SWD and only allows full flash erase and update using a reduced set of the ISP commands.
- 3. Running an application with level CRP3 selected, fully disables any access to the chip via the SWD pins and the ISP. This mode effectively disables ISP override using PIO0_1 pin as well. If necessary, the application must provide a flash update mechanism using IAP calls or using a call to the reinvoke ISP command to enable flash update via the USART.

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					- [4]		
Symbol	Parameter	Conditions		Min	Турш	Max	Unit
I _{OL}	LOW-level output	$V_{OL} = 0.4 V$		4	-	-	mA
	current	$2.0 \text{ V} \leq \text{V}_{\text{DD}} \leq 3.6 \text{ V}$					
		$1.8~V \leq V_{DD} < 2.0~V$		3	-	-	mA
I _{OHS}	HIGH-level short-circuit output current	V _{OH} = 0 V	-	-	-45	mA	
I _{OLS}	LOW-level short-circuit output current	$V_{OL} = V_{DD}$	-	-	50	mA	
I _{pd}	pull-down current	$V_{I} = 5 V$		10	50	150	μA
I _{pu}	pull-up current	$V_{I} = 0 \text{ V};$ 2.0 V $\leq V_{DD} \leq 3.6 \text{ V}$		-15	-50	-85	μΑ
		$1.8 \text{ V} \le \text{V}_{\text{DD}} < 2.0 \text{ V}$		-10	-50	-85	μA
		$V_{DD} < V_I < 5 V$		0	0	0	μA
High-dri	ve output pin (PIO0_7)	ł	-1		1	ł	_
IIL	LOW-level input current	V _I = 0 V; on-chip pull-up resistor disabled		-	0.5	10	nA
I _{IH}	HIGH-level input current	$V_I = V_{DD}$; on-chip pull-down resistor disabled		-	0.5	10	nA
I _{OZ}	OFF-state output current	$V_O = 0 V$; $V_O = V_{DD}$; on-chip pull-up/down resistors disabled		-	0.5	10	nA
V _I input voltage		pin configured to provide a digital function	0	-	5.0	V	
		V _{DD} = 0 V		0	-	3.6	V
Vo	output voltage	output active		0	-	V _{DD}	V
V _{IH}	HIGH-level input voltage			0.7V _{DD}	-	-	V
V _{IL}	LOW-level input voltage			-	-	0.3V _{DD}	V
V _{hys}	hysteresis voltage			0.4	-	-	V
V _{OH}	HIGH-level output	$2.5 \text{ V} \leq \text{V}_{\text{DD}} \leq 3.6 \text{ V}; \text{ I}_{\text{OH}} = -20 \text{ mA}$		$V_{DD}-0.4$	-	-	V
	voltage	$1.8 \text{ V} \le \text{V}_{\text{DD}}$ < 2.5 V; I_{OH} = -12 mA		$V_{DD}-0.4$	-	-	V
V _{OL}	LOW-level output	$2.0 \text{ V} \leq \text{V}_{\text{DD}} \leq 3.6 \text{ V}; \text{ I}_{\text{OL}} = 4 \text{ mA}$		-	-	0.4	V
	voltage	$1.8 \text{ V} \le \text{V}_{\text{DD}}$ < 2.0 V; I_{OL} = 3 mA		-	-	0.4	V
I _{OH}	HIGH-level output current	$V_{OH} = V_{DD} - 0.4 V;$ 2.5 V $\leq V_{DD} \leq 3.6 V$		20	-	-	mA
		$1.8 \text{ V} \le \text{V}_{\text{DD}} < 2.5 \text{ V}$		12	-	-	mA
I _{OL}	LOW-level output current	$V_{OL} = 0.4 \text{ V}$ $2.0 \text{ V} \le \text{V}_{DD} \le 3.6 \text{ V}$		4	-	-	mA
		$1.8 \text{ V} \le \text{V}_{\text{DD}} < 2.0 \text{ V}$		3	-	-	mA
I _{OLS}	LOW-level short-circuit output current	$V_{OL} = V_{DD}$	[11]	-	-	50	mA
I _{pd}	pull-down current	V ₁ = 5 V		10	50	150	μA

Table 5. Static characteristics ...continued

 $T_{amb} = -40 \ ^{\circ}C$ to +85 $^{\circ}C$, unless otherwise specified.





Peripheral	Typical supply current in mA			Notes
	n/a	12 MHz	48 MHz	
IRC	0.27	-	-	System oscillator running; PLL off; independent of main clock frequency.
System oscillator at 12 MHz	0.22	-	-	IRC running; PLL off; independent of main clock frequency.
Watchdog oscillator at 500 kHz/2	0.004	-	-	System oscillator running; PLL off; independent of main clock frequency.
BOD	0.051	-	-	Independent of main clock frequency.
Main PLL	-	0.21	-	-
ADC	-	0.08	0.29	-
CLKOUT	-	0.12	0.47	Main clock divided by 4 in the CLKOUTDIV register.
CT16B0	-	0.02	0.06	-
CT16B1	-	0.02	0.06	-
CT32B0	-	0.02	0.07	-
CT32B1	-	0.02	0.06	-
GPIO	-	0.23	0.88	GPIO pins configured as outputs and set to LOW. Direction and pin state are maintained if the GPIO is disabled in the SYSAHBCLKCFG register.
IOCONFIG	-	0.03	0.10	-
l ² C	-	0.04	0.13	-
ROM	-	0.04	0.15	-
SPI0	-	0.12	0.45	-
SPI1	-	0.12	0.45	-
UART	-	0.22	0.82	-
WWDT	-	0.02	0.06	Main clock selected as clock source for the WDT.

 Table 8.
 Power consumption for individual analog and digital blocks

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10.6 SSP interface

Table 16. Dynamic characteristics of SPI pins in SPI mode

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
SPI maste	er (in SPI mode)	1	1				I
T _{cy(clk)}	clock cycle time	full-duplex mode	[1]	50	-	-	ns
		when only transmitting	[1]	40			ns
t _{DS}	data set-up time	in SPI mode	[2]	15	-	-	ns
		$2.4~V \leq V_{DD} \leq 3.6~V$					
		$2.0~\textrm{V} \leq \textrm{V}_\textrm{DD} < 2.4~\textrm{V}$	[2]	20			ns
		$1.8 \text{ V} \le \text{V}_{\text{DD}}$ < 2.0 V	[2]	24	-	-	ns
t _{DH}	data hold time	in SPI mode	[2]	0	-	-	ns
t _{v(Q)}	data output valid time	in SPI mode	[2]	-	-	10	ns
t _{h(Q)}	data output hold time	in SPI mode	[2]	0	-	-	ns
SPI slave	(in SPI mode)			1			
T _{cy(PCLK)}	PCLK cycle time			20	-	-	ns
t _{DS}	data set-up time	in SPI mode	[3][4]	0	-	-	ns
t _{DH}	data hold time	in SPI mode	[3][4]	$3 \times T_{cy(PCLK)} + 4$	-	-	ns
t _{v(Q)}	data output valid time	in SPI mode	[3][4]	-	-	$3 \times T_{cy(PCLK)}$ + 11	ns
t _{h(Q)}	data output hold time	in SPI mode	[3][4]	-	-	$2 \times T_{cy(PCLK)}$ + 5	ns

[1] $T_{cy(clk)} = (SSPCLKDIV \times (1 + SCR) \times CPSDVSR) / f_{main}$. The clock cycle time derived from the SPI bit rate $T_{cy(clk)}$ is a function of the main clock frequency f_{main} , the SPI peripheral clock divider (SSPCLKDIV), the SPI SCR parameter (specified in the SSP0CR0 register), and the SPI CPSDVSR parameter (specified in the SPI clock prescale register).

[2] $T_{amb} = -40 \ ^{\circ}C$ to 85 $^{\circ}C$.

 $[3] \quad T_{cy(clk)} = 12 \times T_{cy(PCLK)}.$

[4] $T_{amb} = 25 \text{ °C}$; for normal voltage supply range: $V_{DD} = 3.3 \text{ V}$.



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Table 17.Recommended values for C_{X1}/C_{X2} in oscillation mode (crystal and external
components parameters) low frequency mode

Fundamental oscillation frequency F _{OSC}	Crystal load capacitance C _L	Maximum crystal series resistance R _S	External load capacitors C _{X1} , C _{X2}
1 MHz to 5 MHz	10 pF	< 300 Ω	18 pF, 18 pF
	20 pF	< 300 Ω	39 pF, 39 pF
	30 pF	< 300 Ω	57 pF, 57 pF
5 MHz to 10 MHz	10 pF	< 300 Ω	18 pF, 18 pF
	20 pF	< 200 Ω	39 pF, 39 pF
	30 pF	< 100 Ω	57 pF, 57 pF
10 MHz to 15 MHz	10 pF	< 160 Ω	18 pF, 18 pF
	20 pF	< 60 Ω	39 pF, 39 pF
15 MHz to 20 MHz	10 pF	< 80 Ω	18 pF, 18 pF

Table 18. Recommended values for C_{χ_1}/C_{χ_2} in oscillation mode (crystal and external components parameters) high frequency mode

Fundamental oscillation frequency F _{OSC}	Crystal load capacitance C _L	Maximum crystal series resistance R _S	External load capacitors C _{X1} , C _{X2}
15 MHz to 20 MHz	10 pF	< 180 Ω	18 pF, 18 pF
	20 pF	< 100 Ω	39 pF, 39 pF
20 MHz to 25 MHz	10 pF	< 160 Ω	18 pF, 18 pF
	20 pF	< 80 Ω	39 pF, 39 pF

11.2 XTAL Printed-Circuit Board (PCB) layout guidelines

Follow these guidelines for PCB layout:

- Connect the crystal on the PCB as close as possible to the oscillator input and output pins of the chip.
- Take care that the load capacitors C_{x1}, C_{x2}, and C_{x3} in case of third overtone crystal use have a common ground plane.

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11.4 Reset pad configuration

11.5 ADC effective input impedance

A simplified diagram of the ADC input channels can be used to determine the effective input impedance seen from an external voltage source. See <u>Figure 30</u>.



The effective input impedance, R_{in}, seen by the external voltage source, V_{EXT}, is the parallel impedance of $((1/f_s \times C_{ia}) + R_{mux} + R_{sw})$ and $(1/f_s \times C_{io})$, and can be calculated using Equation 1 with

fs = sampling frequency

Cia = ADC analog input capacitance

R_{mux} = analog mux resistance

R_{sw} = switch resistance

Cio = pin capacitance

$$R_{in} = \left(\frac{1}{f_s \times C_{ia}} + R_{mux} + R_{sw}\right) \| \left(\frac{1}{f_s \times C_{io}}\right)$$
(1)

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11.7.3 I/O Handler I²C

The I/O Handler I²C library allows to have an additional I²C-bus master. I²C read, I²C write and combined I²C read/write are supported. Data is automatically read from and written to user-defined buffers.

The I/O Handler I²C library combined with the on-chip I²C module allows to have two distinct I²C buses, allowing to separate low-speed from high-speed devices or bridging two I²C buses.

11.7.4 I/O Handler DMA

The I/O Handler DMA library offers DMA-like functionality. Four types of transfer are supported: memory to memory, memory to peripheral, peripheral to memory and peripheral to peripheral. Supported peripherals are USART, SSP0/1, ADC and GPIO. DMA transfers can be triggered by the source/target peripheral, software, counter/timer module CT16B1, or I/O Handler pin PIO1_6/IOH_16.

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